

EVALUATION KIT
AVAILABLE

2.5/5.0/8.0Gbps PCIe Passive Switches

General Description

The MAX4889B/MAX4889C high-speed passive switches route PCI Express® (PCIe) data between two possible destinations in desktop or notebook PCs. The MAX4889B/MAX4889C are quad double-pole/double-throw (4 x DPDT) switches ideal for switching four half lanes of PCIe data between two destinations. The MAX4889B/MAX4889C feature a single digital control input (SEL) to switch signal paths.

The MAX4889C is intended for use in systems (e.g., SAS) where both the input and output are capacitively coupled, and provides a 10 μ A (typ) source current and a 60k Ω (typ) internal biasing resistor to GND at the _OUT_ terminals.

The MAX4889B/MAX4889C are fully specified to operate from a single +3.3V (typ) power supply. Both devices are available in an industry-standard 3.5mm x 9.0mm, 42-pin TQFN package. These devices operate over the -40°C to +85°C extended temperature range.

Applications

Desktop PCs
 Notebook PCs
 Servers
 Video Graphics Cards—SLI®
 (Scaled Link Interface) and CrossFire™

PCI Express is a registered service mark of PCI-SIG Corporation.

SLI is a registered trademark of NVIDIA Corporation.

CrossFire is a trademark of ATI Technologies, Inc.

Features

- ◆ Single +3.3V Power-Supply Voltage
- ◆ Support PCIe Gen I, Gen II, and Gen III Data Rates
- ◆ Supports SAS I, SAS II, and SAS 6.0Gbps (MAX4889C)
- ◆ Superior Return Loss
Better than -10dB (typ) at 5.0GHz
- ◆ Small 3.5mm x 9.0mm, 42-Pin TQFN Package
- ◆ Industry-Standard Pinouts

Ordering Information

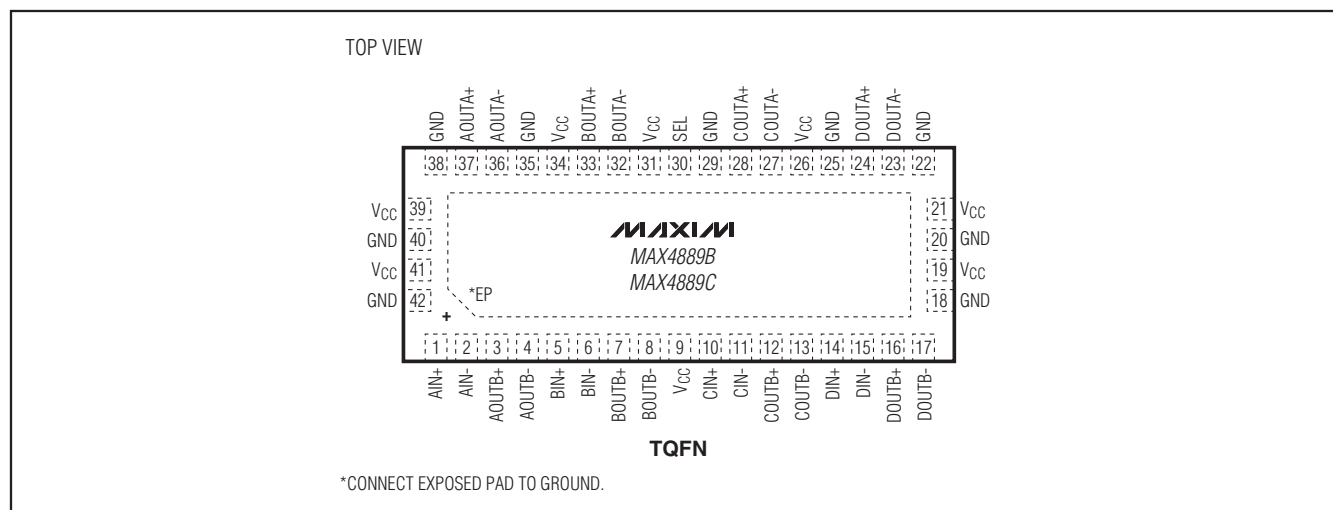
| PART | TEMP RANGE | PIN-PACKAGE |
|--------------|----------------|-------------|
| MAX4889BETO+ | -40°C to +85°C | 42 TQFN-EP* |
| MAX4889CETO+ | -40°C to +85°C | 42 TQFN-EP* |

+ Denotes a lead (Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Typical Operating Circuit appears at end of data sheet.

Pin Configuration



2.5/5.0/8.0Gbps PCIe Passive Switches

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND, unless otherwise noted.)

| | |
|--|-----------------------------------|
| V _{CC} | -0.3V to +4V |
| SEL, _IN_, _OUTA_, _OUTB_ (Note 1)..... | -0.3V to (V _{CC} + 0.3V) |
| Continuous Current (AIN_ to AOUTA_/AOUTB_, BIN_ to BOUTA_/BOUTB_, CIN_ to COUTA_/COUTB_, DIN_ to DOUTA_/DOUTB_)..... | ±70mA |
| Peak Current (AIN_ to AOUTA_/AOUTB_, BIN_ to BOUTA_/BOUTB_, CIN_ to COUTA_/COUTB_, DIN_ to DOUTA_/DOUTB_) (pulsed at 1ms, 10% duty cycle)..... | ±70mA |
| Continuous Current (SEL)..... | ±10mA |
| Peak Current (SEL) (pulsed at 1ms, 10% duty cycle)..... | ±10mA |

| | |
|--|-----------------|
| Continuous Power Dissipation (T _A = +70°C) for multilayer board: 42-Pin TQFN (derate 35.7mW/°C above +70°C)..... | 2857mW |
| Operating Temperature Range..... | -40°C to +85°C |
| Junction Temperature..... | +150°C |
| Storage Temperature Range..... | -65°C to +150°C |
| Package Junction-to-Ambient Thermal Resistance (θ _{JA}) (Note 2)..... | 28.0°C/W |
| Package Junction-to-Case Thermal Resistance (θ _{JC}) (Note 2)..... | 2.0°C/W |
| Lead Temperature (soldering, 10s)..... | +300°C |
| Soldering Temperature (reflow)..... | +260°C |

Note 1: Signals on SEL, _IN_, _OUTA_, _OUTB_ exceeding V_{CC} or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maxim-ic.com/thermal-tutorial.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +3.3V ±10%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at V_{CC} = +3.3V, T_A = +25°C, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--|---|------|-----|-----------------------|-------|
| DC PERFORMANCE | | | | | | |
| Analog Signal Range | _IN_, _OUTA_, _OUTB_ | | -0.3 | | V _{CC} - 1.8 | V |
| On-Resistance | R _{ON} | V _{CC} = +3.0V, I _{_IN_} = 15mA, V _{_OUTA_} , V _{_OUTB_} = 0V, 1.2V | | 6.4 | 8.4 | Ω |
| On-Resistance Match Between Pairs of Same Channel | ΔR _{ON} | V _{CC} = +3.0V, I _{_IN_} = 15mA, V _{_OUTA_} , V _{_OUTB_} = 0V (Notes 4, 5) | | 0.1 | 0.5 | Ω |
| On-Resistance Match Between Channels | ΔR _{ON} | V _{CC} = +3.0V, I _{_IN_} = 15mA, V _{_OUTA_} , V _{_OUTB_} = 0V (Notes 4, 5) | | 0.2 | | Ω |
| On-Resistance Flatness | R _{FLAT (ON)} | V _{CC} = +3.0V, I _{_IN_} = 15mA, V _{_OUTA_} , V _{_OUTB_} = 0V, 1.2V (Notes 5, 6) | | 0.3 | | Ω |
| _OUTA_ or _OUTB_ Off-Leakage Current | I _{_OUTA_ (OFF)} , I _{_OUTB_ (OFF)} | V _{CC} = +3.6V, V _{_IN_} = 0V, 1.2V, V _{_OUTA_} or V _{_OUTB_} = 1.2V, 0V (MAX4889B) | -1 | | +1 | μA |
| _IN_ On-Leakage Current | I _{_IN_ (ON)} | V _{CC} = +3.6V, V _{_IN_} = 0V, 1.2V, V _{_OUTA_} or V _{_OUTB_} = V _{_IN_} or unconnected (MAX4889B) | -1 | | +1 | μA |
| Output Short-Circuit Current | | All other ports are unconnected (MAX4889C) | 5 | | 15 | μA |
| Output Open-Circuit Voltage | | All other ports are unconnected (MAX4889C) | 0.2 | 0.6 | 0.9 | V |

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MAX4889B/MAX4889C

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +3.3V ±10%, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at V_{CC} = +3.3V, T_A = +25°C, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--------------------------------------|-----------------------|---|-----|-----|-----|-------|
| AC PERFORMANCE | | | | | | |
| SEL-to-Switch Turn-On Time | t _{ON_SEL} | Z _S = Z _L = 50Ω | | 80 | | ns |
| SEL-to-Switch Turn-Off Time | t _{OFF_SEL} | Z _S = Z _L = 50Ω, Figure 1 | | 15 | | ns |
| Propagation Delay | t _{PD} | Z _S = Z _L = 50Ω, Figure 2 | | 50 | | ps |
| Output Skew Between Pairs | t _{SKEW1} | Z _S = Z _L = 50Ω, Figure 2 | | 50 | | ps |
| Output Skew Between Same Pair | t _{SKEW2} | Z _S = Z _L = 50Ω, Figure 2 | | 10 | | ps |
| Differential Return Loss (Note 5) | S _{DD11} | 0Hz < f ≤ 2.8GHz | -14 | | | dB |
| | | 2.8GHz < f ≤ 5.0GHz | -8 | | | |
| | | f > 5.0GHz | -3 | | | |
| Differential Insertion Loss (Note 5) | S _{DD21} | See Table 1 | | | | dB |
| Differential Crosstalk (Note 5) | S _{DDCTK} | 0Hz < f ≤ 2.5GHz | | -40 | | dB |
| | | 2.5GHz < f ≤ 5.0GHz | | -30 | | |
| | | f > 5.0GHz | | -25 | | |
| Differential Off-Isolation (Note 5) | S _{DD21_OFF} | 0Hz < f ≤ 2.5GHz | | -15 | | dB |
| | | 2.5GHz < f ≤ 5.0GHz | | -12 | | |
| | | f > 5.0GHz | | -12 | | |
| CONTROL INPUT (SEL) | | | | | | |
| Input Logic High | V _{IH} | | 1.4 | | | V |
| Input Logic Low | V _{IL} | | | | 0.6 | V |
| Input Logic Hysteresis | V _{HYST} | | | 130 | | mV |
| POWER SUPPLY | | | | | | |
| Power-Supply Range | V _{CC} | | 3.0 | | 3.6 | V |
| V _{CC} Supply Current | I _{CC} | V _{SEL} = 0V or V _{CC} | | | 1 | mA |

Note 3: All units are 100% production tested at T_A = +85°C. Limits over the operating temperature range are guaranteed by design and characterization and are not production tested.

Note 4: ΔR_{ON} = R_{ON} (MAX) - R_{ON} (MIN).

Note 5: Guaranteed by design, not production tested.

Note 6: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal range.

Table 1. Insertion Loss Mask

| FREQUENCY RANGE (GHz) | MAXIMUM INSERTION LOSS (dB) |
|-----------------------|---|
| 0–2.5 | $\frac{14}{25} \times f_{\text{GHz}} + 0.6$ |
| 2.5–5 | $\frac{6}{5} \times f_{\text{GHz}} - 1.0$ |
| 5 or greater | $\frac{8}{5} \times f_{\text{GHz}} - 3.0$ |

2.5/5.0/8.0Gbps PCIe Passive Switches

Test Circuits/Timing Diagrams

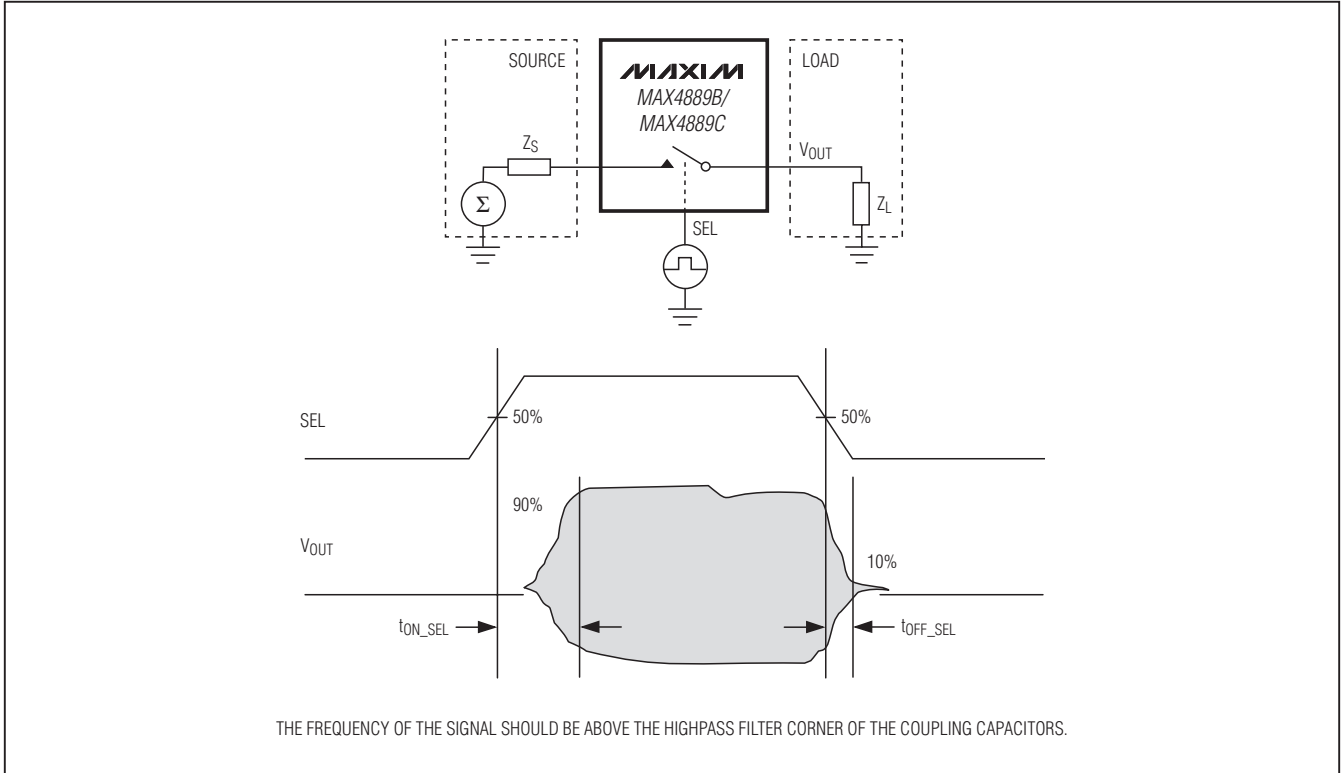


Figure 1. Switching Time

2.5/5.0/8.0Gbps PCIe Passive Switches

Test Circuits/Timing Diagrams (continued)

MAX4889B/MAX4889C

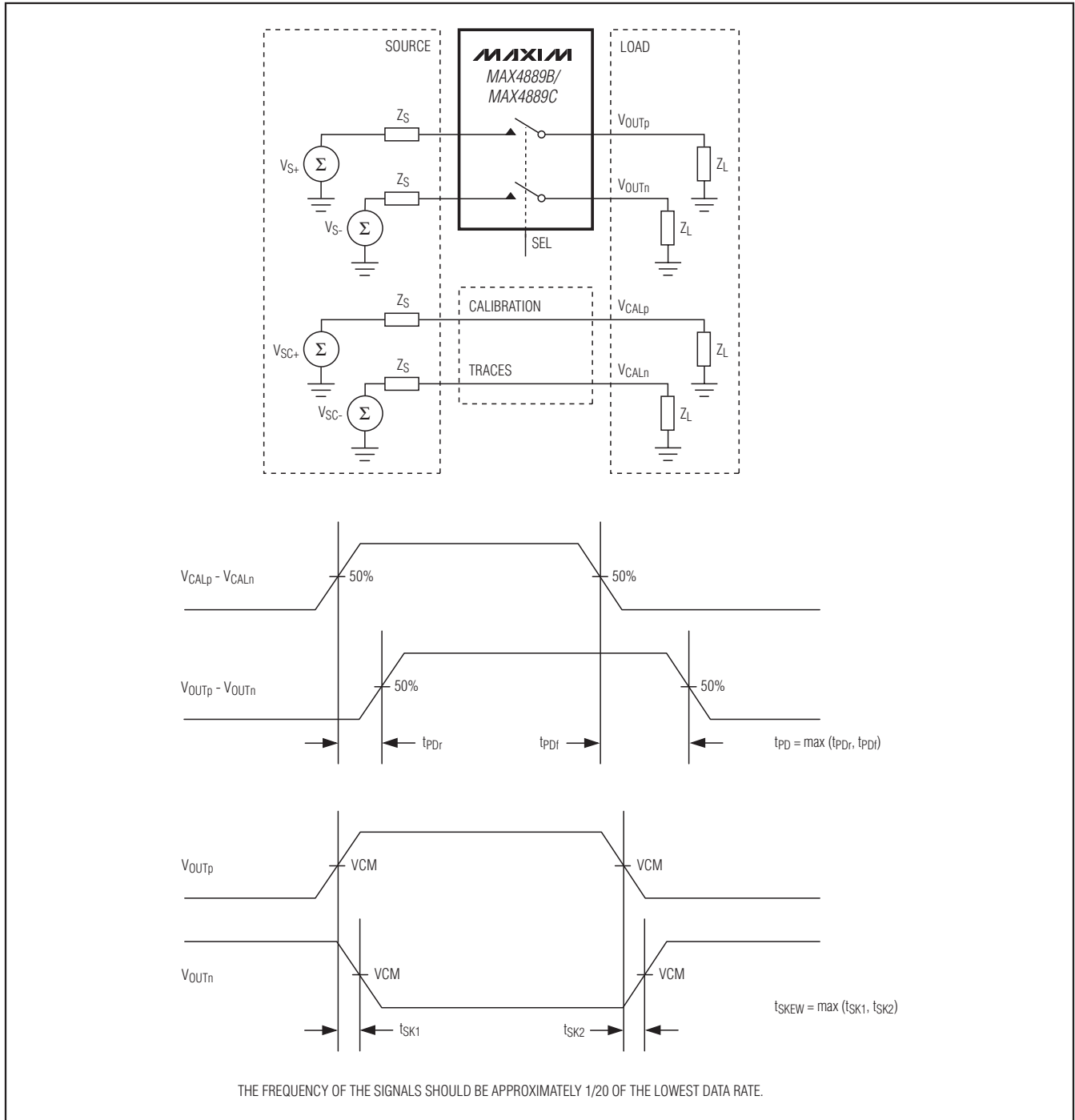
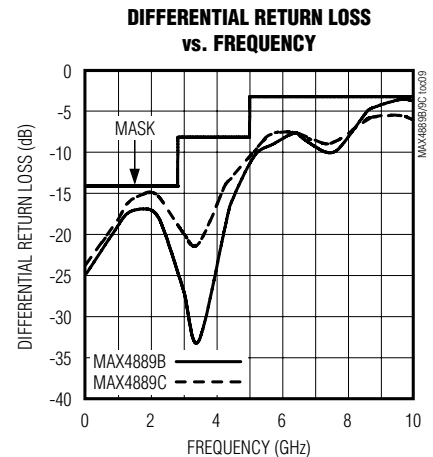
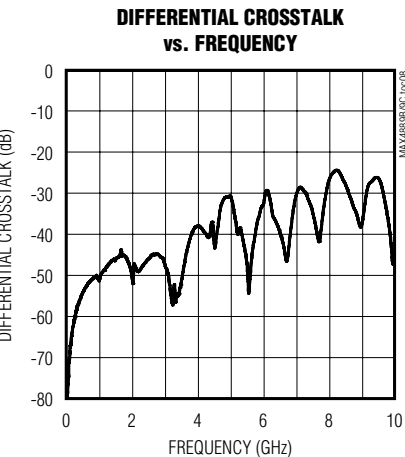
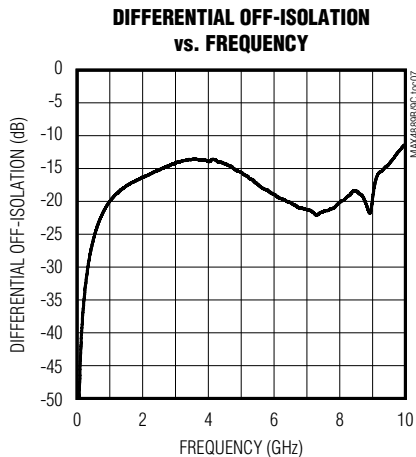
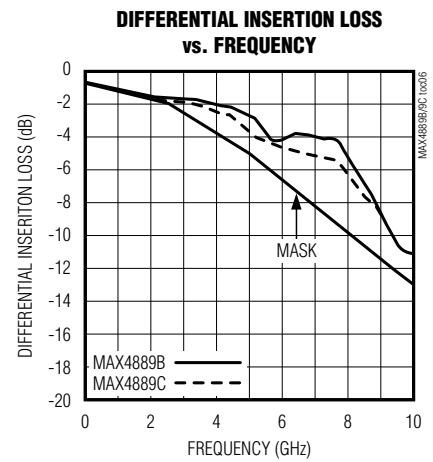
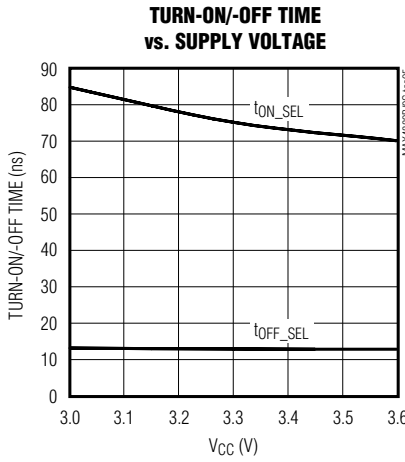
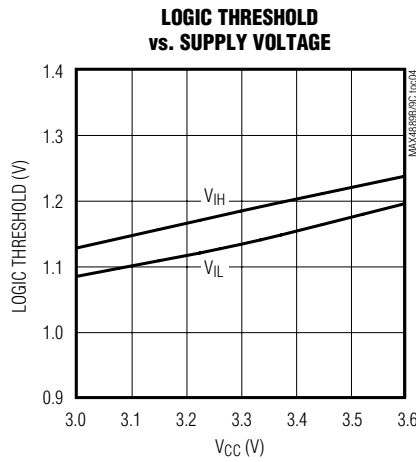
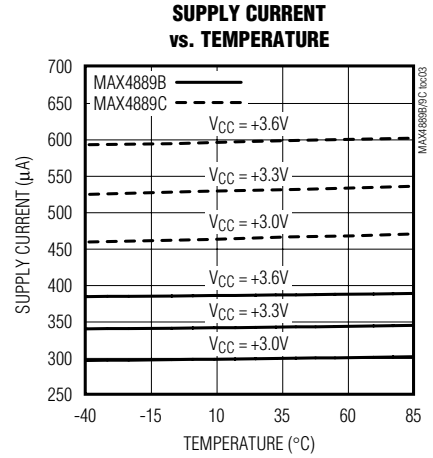
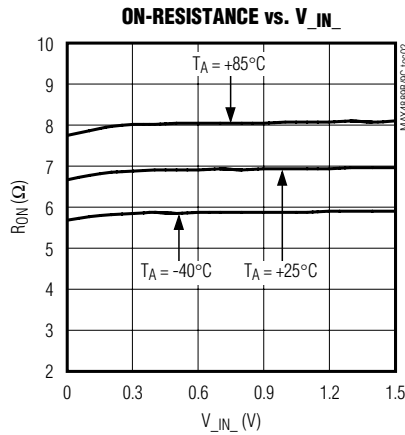
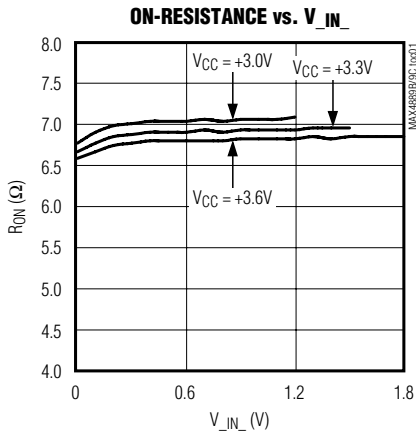


Figure 2. Propagation Delay and Output Skew

2.5/5.0/8.0Gbps PCIe Passive Switches

Typical Operating Characteristics

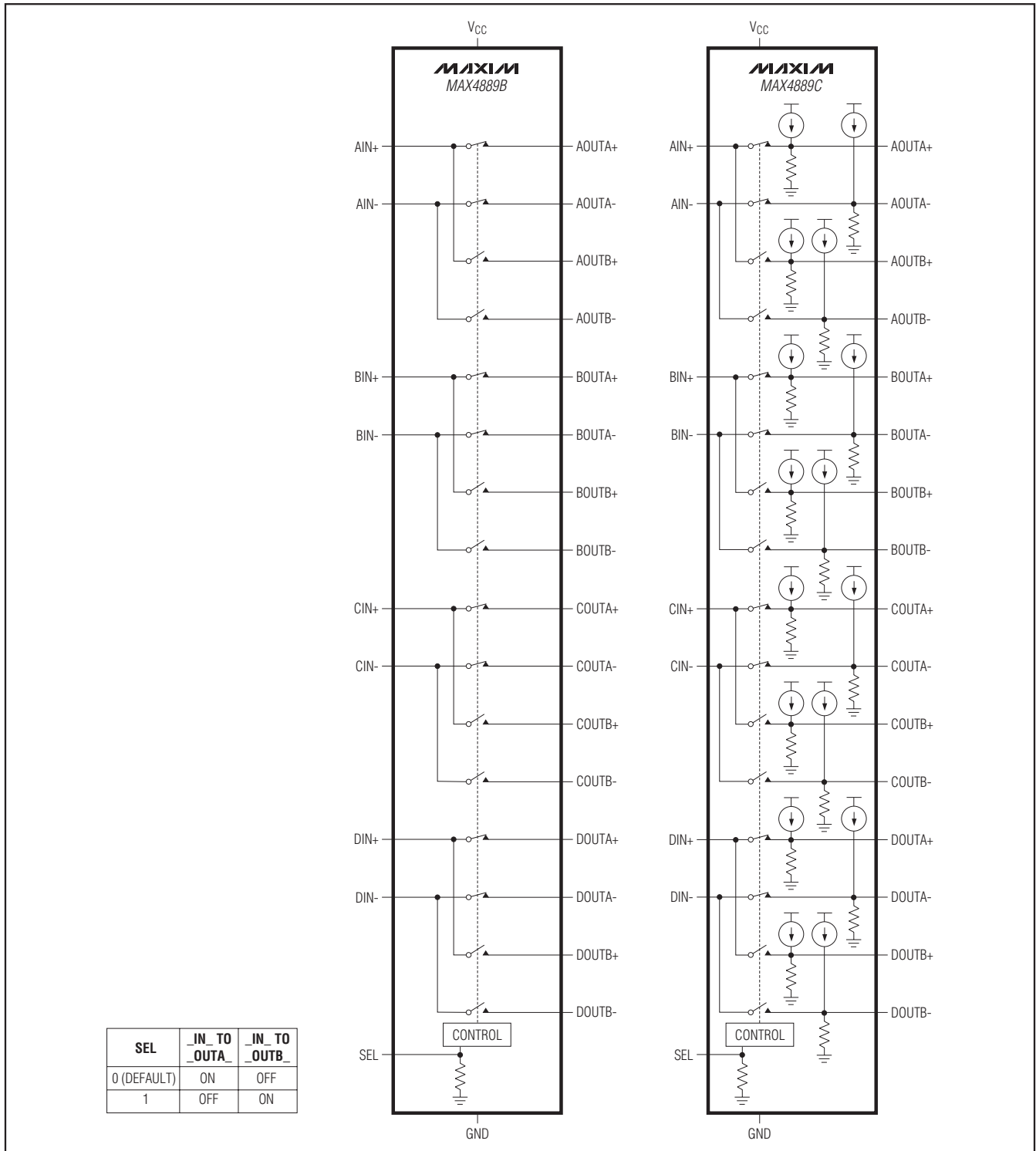
($V_{CC} = +3.3V$, $T_A = +25^\circ C$, unless otherwise noted.)



2.5/5.0/8.0Gbps PCIe Passive Switches

Functional Diagram/Truth Table

MAX4889B/MAX4889C



2.5/5.0/8.0Gbps PCIe Passive Switches

Pin Description

| PIN | NAME | FUNCTION |
|---------------------------------------|-----------------|---|
| MAX4889B/ MAX4889C | | |
| 1 | AIN+ | Analog Switch 1. Common Positive Terminal. |
| 2 | AIN- | Analog Switch 1. Common Negative Terminal. |
| 3 | AOUTB+ | Analog Switch 1. Normally Open Positive Terminal. |
| 4 | AOUTB- | Analog Switch 1. Normally Open Negative Terminal. |
| 5 | BIN+ | Analog Switch 2. Common Positive Terminal. |
| 6 | BIN- | Analog Switch 2. Common Negative Terminal. |
| 7 | BOUTB+ | Analog Switch 2. Normally Open Positive Terminal. |
| 8 | BOUTB- | Analog Switch 2. Normally Open Negative Terminal. |
| 9, 19, 21, 26, 31, 34, 39, 41 | V _{CC} | Positive Supply Voltage Input. Connect V _{CC} to a 3.0V to 3.6V supply voltage. Bypass V _{CC} to GND with a 0.1µF ceramic capacitor placed as close as possible to the device. See the <i>Board Layout</i> section. |
| 10 | CIN+ | Analog Switch 3. Common Positive Terminal. |
| 11 | CIN- | Analog Switch 3. Common Negative Terminal. |
| 12 | COUTB+ | Analog Switch 3. Normally Open Positive Terminal. |
| 13 | COUTB- | Analog Switch 3. Normally Open Negative Terminal. |
| 14 | DIN+ | Analog Switch 4. Common Positive Terminal. |
| 15 | DIN- | Analog Switch 4. Common Negative Terminal. |
| 16 | DOUTB+ | Analog Switch 4. Normally Open Positive Terminal. |
| 17 | DOUTB- | Analog Switch 4. Normally Open Negative Terminal. |
| 18, 20, 22, 25, 29, 35, 38, 40, 42 | GND | Ground |
| 23 | DOUTA- | Analog Switch 4. Normally Closed Negative Terminal. |
| 24 | DOUTA+ | Analog Switch 4. Normally Closed Positive Terminal. |
| 27 | COUTA- | Analog Switch 3. Normally Closed Negative Terminal. |
| 28 | COUTA+ | Analog Switch 3. Normally Closed Positive Terminal. |
| 30 | SEL | Control Signal Input. SEL has a 70kΩ (typ) pulldown resistor to GND. |
| 32 | BOUTA - | Analog Switch 2. Normally Closed Negative Terminal. |
| 33 | BOUTA+ | Analog Switch 2. Normally Closed Positive Terminal. |
| 36 | AOUTA- | Analog Switch 1. Normally Closed Negative Terminal. |
| 37 | AOUTA+ | Analog Switch 1. Normally Closed Positive Terminal. |
| — | EP | Exposed Pad. Connect EP to GND. |

2.5/5.0/8.0Gbps PCIe Passive Switches

MAX4889B/MAX4889C

Detailed Description

The MAX4889B high-speed passive switch routes PCI Express (PCIe) data or other high-speed signals with amplitude of $\leq 1.2V_{P-P}$ differential, and common-mode voltage close to 0V between two possible destinations. The MAX4889B is ideal for routing PCIe signals to change system configuration. For example, in a graphics application, four MAX4889B devices create two sets of eight lanes from a single 16-lane bus. The MAX4889C feature a $10\mu A$ (typ) source current and a $60k\Omega$ (typ) internal biasing resistor to GND at the $_OUT_$ terminals. The MAX4889C is ideal for dual capacitively coupled applications such as SAS and SATA. The MAX4889B/MAX4889C feature a single digital control input (SEL) to switch signal paths. SEL has a $70k\Omega$ (typ) pulldown resistor to GND.

The MAX4889B/MAX4889C are fully specified to operate from a single 3.0V to 3.6V power supply.

Digital Control Input (SEL)

The MAX4889B/MAX4889C provide a single digital control input (SEL) to select the signal path between the $_IN_$ and $_OUT_$ channels. The truth tables for the MAX4889B/MAX4889C are illustrated in the *Functional Diagram/Truth Table*. SEL has a $70k\Omega$ (typ) pulldown resistor to GND.

Analog Signal Levels

The MAX4889B/MAX4889C accept standard PCIe signals to a maximum of ($V_{CC} - 1.8V$). Signals on the $_IN+$ channels are routed to either the $_OUTA+$ or $_OUTB+$ channels. Signals on the $_IN-$ channels are routed to either the $_OUTA-$ or $_OUTB-$ channels. The MAX4889B/MAX4889C are bidirectional switches, allowing $_IN_$ and $_OUT_$ to be used as either inputs or outputs.

Applications Information

PCIe Switching

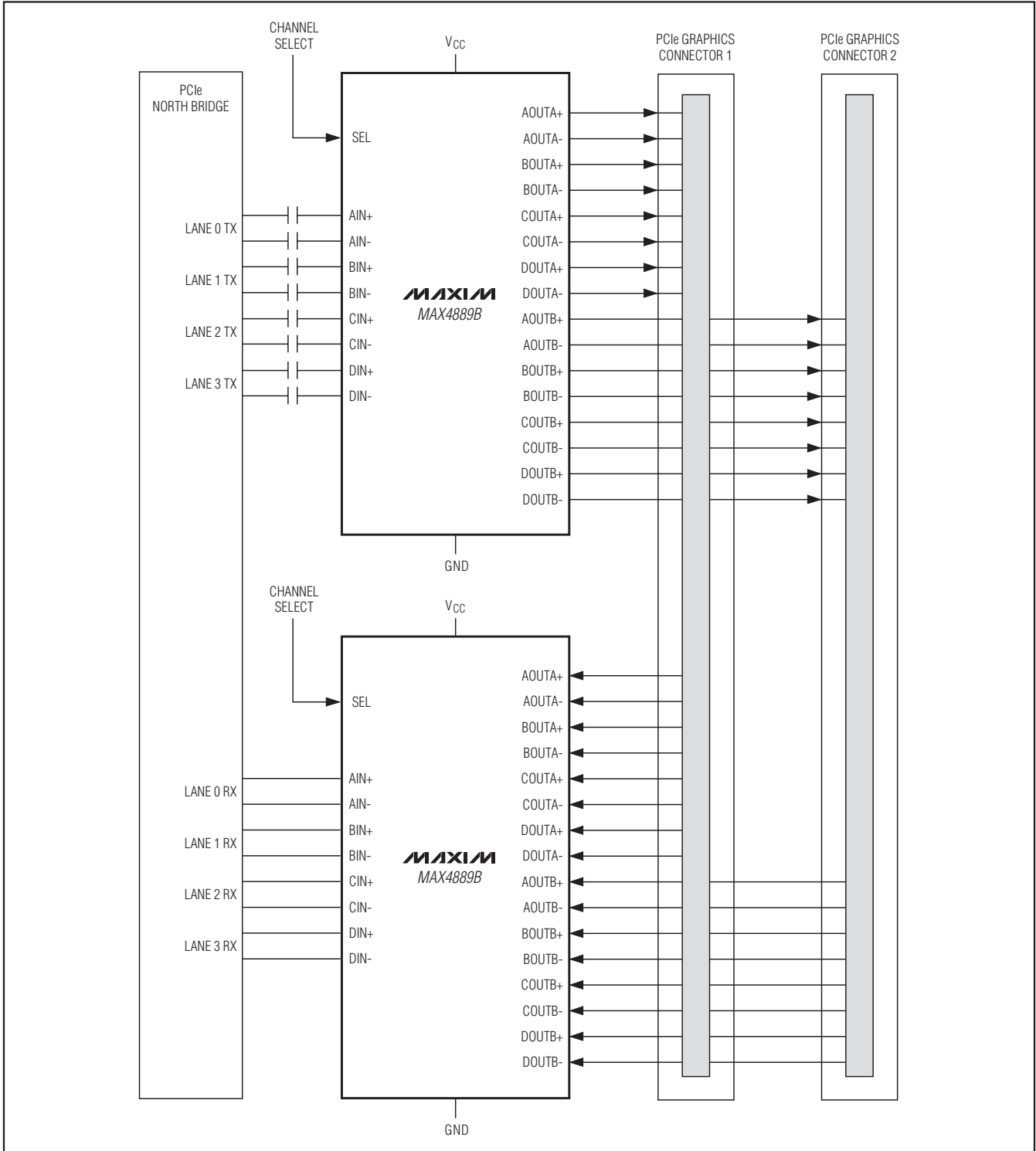
The MAX4889B/MAX4889C primary applications are aimed at reallocating PCIe lanes (see the *Typical Operating Circuit: Video Graphics Cards*). For example, in graphics applications, several manufacturers have found that it is possible to improve performance by a factor of nearly two by splitting a single 16-lane PCIe bus into two 8-lane buses. Two of the more prominent examples are SLI (Scaled Link Interface) and CrossFire. Four MAX4889Bs permit a computer motherboard to operate properly with a single 16-lane graphics card, which can later be upgraded to dual cards.

Board Layout

High-speed switches require proper layout and design procedures for optimum performance. Keep controlled-impedance PCB traces as short as possible or follow impedance layouts per the PCIe specification. Ensure that power-supply bypass capacitors are placed as close as possible to the device. Multiple bypass capacitors are recommended. Connect all grounds and the exposed pad to large ground planes.

2.5/5.0/8.0Gbps PCIe Passive Switches

Typical Operating Circuit: Video Graphics Cards



2.5/5.0/8.0Gbps PCIe Passive Switches

Chip Information

PROCESS: CMOS

Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO. | LAND PATTERN NO. |
|--------------|--------------|-------------------------|-------------------------|
| 42 TQFN | T423590M+1 | 21-0181 | 90-0079 |

MAX4889B/MAX4889C

2.5/5.0/8.0Gbps PCIe Passive Switches

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|---|---------------|
| 2 | 8/10 | Added 8.0Gbps PCIe passive switch to the title; added Gen III to the data rates in the <i>Features</i> section; changed the return loss in the <i>Features</i> section to -10dB (typ) at 5.0GHz | All |

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